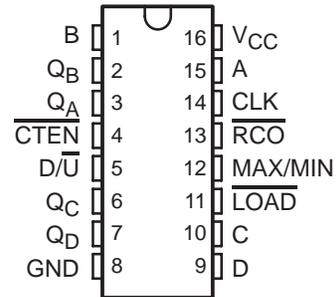


SN54HC191, SN74HC191 4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

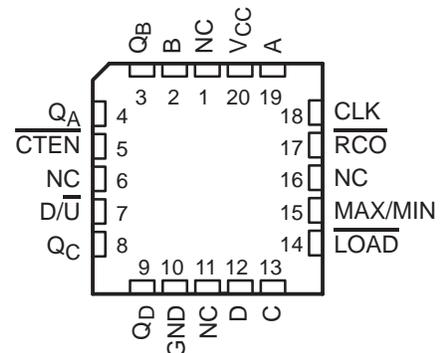
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- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 13$ ns
- ± 4 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Single Down/Up Count-Control Line
- Look-Ahead Circuitry Enhances Speed of Cascaded Counters
- Fully Synchronous in Count Modes
- Asynchronously Presetable With Load Control

SN54HC191 . . . J OR W PACKAGE
SN74HC191 . . . D, N, OR NS PACKAGE
(TOP VIEW)



SN54HC191 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The 'HC191 devices are 4-bit synchronous, reversible, up/down binary counters. Synchronous counting operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple-clock) counters.

The outputs of the four flip-flops are triggered on a low- to high-level transition of the clock (CLK) input if the count-enable (\overline{CTEN}) input is low. A high at \overline{CTEN} inhibits counting. The direction of the count is determined by the level of the down/up (D/U) input. When D/U is low, the counter counts up, and when D/U is high, it counts down.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube of 25	SN74HC191N	SN74HC191N
	SOIC – D	Tube of 40	SN74HC191D	HC191
		Reel of 2500	SN74HC191DR	
		Reel of 250	SN74HC191DT	
SOP – NS	Reel of 2000	SN74HC191NSR	HC191	
-55°C to 125°C	CDIP – J	Tube of 25	SNJ54HC191J	SNJ54HC191J
	CFP – W	Tube of 150	SNJ54HC191W	SNJ54HC191W
	LCCC – FK	Tube of 55	SNJ54HC191FK	SNJ54HC191FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54HC191, SN74HC191

4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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description/ordering information (continued)

These counters feature a fully independent clock circuit. Change at the control (\overline{CTEN} and D/\overline{U}) inputs that modifies the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter is dictated solely by the condition meeting the stable setup and hold times.

These counters are fully programmable; that is, each of the outputs can be preset to either level by placing a low on the load (\overline{LOAD}) input and entering the desired data at the data inputs. The output changes to agree with the data inputs independently of the level of CLK. This feature allows the counters to be used as modulo-N dividers simply by modifying the count length with the preset inputs.

Two outputs are available to perform the cascading function: ripple clock (\overline{RCO}) and maximum/minimum (MAX/MIN) count. MAX/MIN produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock while the count is zero (all outputs low) counting down, or maximum (9 or 15) counting up. \overline{RCO} produces a low-level output pulse under those same conditions, but only while CLK is low. The counters can be cascaded easily by feeding \overline{RCO} to \overline{CTEN} of the succeeding counter if parallel clocking is used, or to CLK if parallel enabling is used. MAX/MIN can be used to accomplish look ahead for high-speed operation.

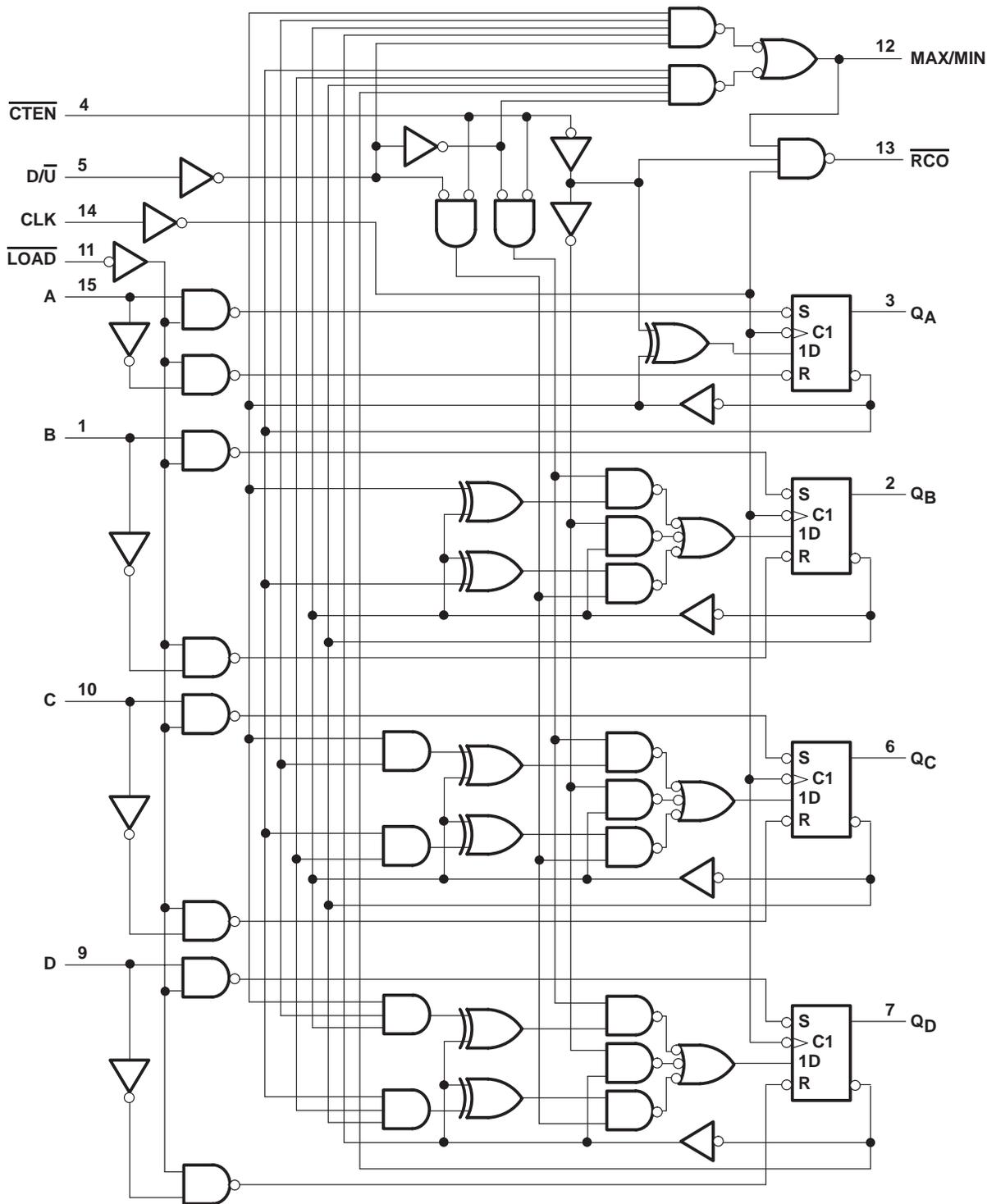


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SN54HC191, SN74HC191 4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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logic diagram (positive logic)



Pin numbers shown are for the D, J, N, NS, and W packages.

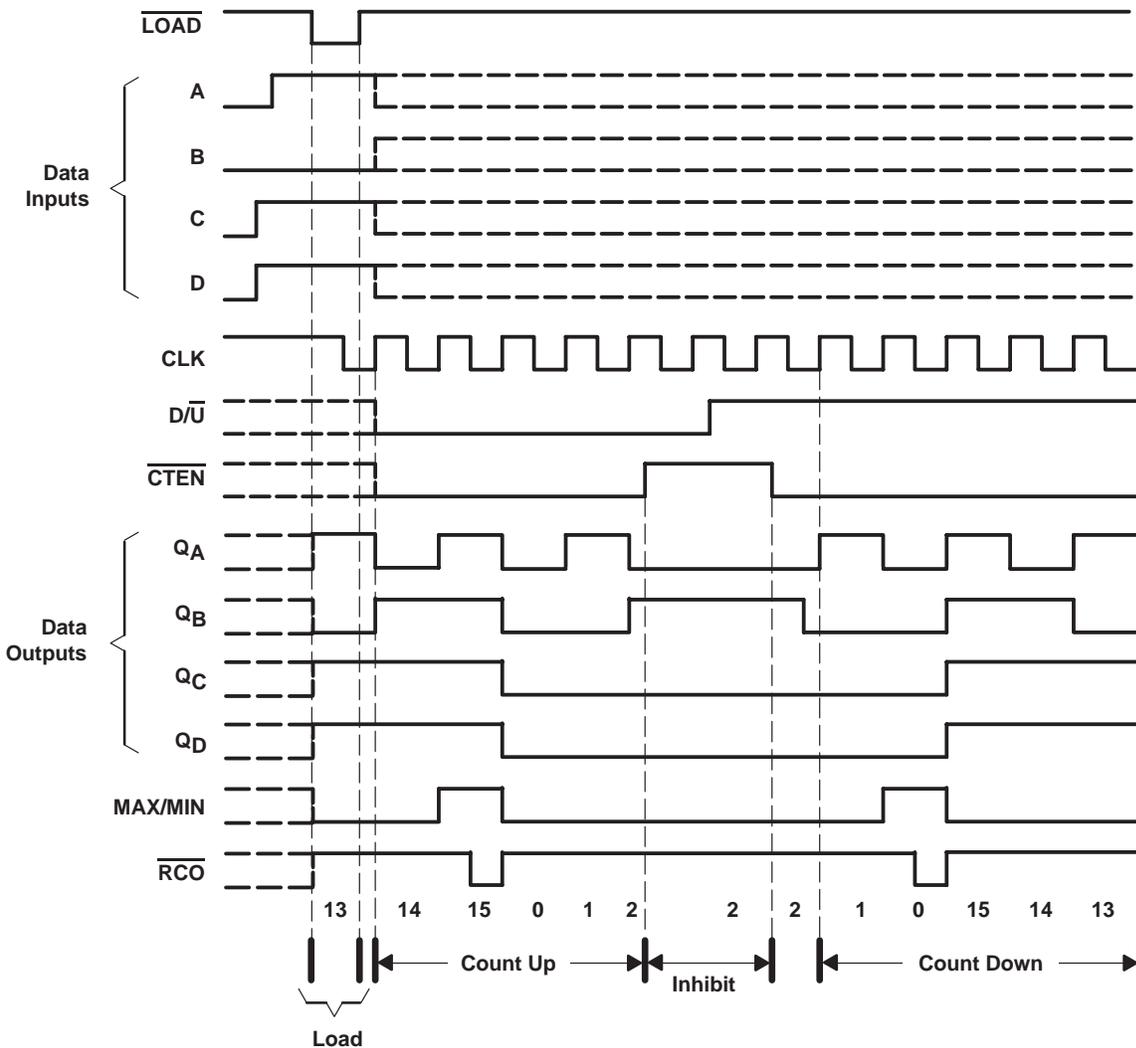
SN54HC191, SN74HC191 4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

SCLS121D – DECEMBER 1982 – REVISED OCTOBER 2003

typical load, count, and inhibit sequence

The following sequence is illustrated below:

1. Load (preset) to binary 13
2. Count up to 14, 15 (maximum), 0, 1, and 2
3. Inhibit
4. Count down to 1, 0 (minimum), 15, 14, and 13



SN54HC191, SN74HC191

4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): D package	73°C/W
N package	67°C/W
NS package	64°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		SN54HC191			SN74HC191			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	2	5	6	2	5	6	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V		1.5	$V_{CC} = 2$ V		1.5	V
		$V_{CC} = 4.5$ V		3.15	$V_{CC} = 4.5$ V		3.15	
		$V_{CC} = 6$ V		4.2	$V_{CC} = 6$ V		4.2	
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V			0.5	$V_{CC} = 2$ V		0.5
		$V_{CC} = 4.5$ V			1.35	$V_{CC} = 4.5$ V		1.35
		$V_{CC} = 6$ V			1.8	$V_{CC} = 6$ V		1.8
V_I	Input voltage	0		V_{CC}	0		V_{CC}	V
V_O	Output voltage	0		V_{CC}	0		V_{CC}	V
$\Delta t/\Delta v$ ‡	Input transition rise/fall time	$V_{CC} = 2$ V			1000	$V_{CC} = 2$ V		1000
		$V_{CC} = 4.5$ V			500	$V_{CC} = 4.5$ V		500
		$V_{CC} = 6$ V			400	$V_{CC} = 6$ V		400
T_A	Operating free-air temperature	–55		125	–40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

‡ If this device is used in the threshold region (from $V_{ILmax} = 0.5$ V to $V_{IHmin} = 1.5$ V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at $t_f = 1000$ ns and $V_{CC} = 2$ V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.



SN54HC191, SN74HC191

4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V _{CC}	T _A = 25°C			SN54HC191		SN74HC191		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	V _I = V _{IH} or V _{IL}	I _{OH} = -20 μA	2 V	1.9	1.998		1.9		1.9	V	
			4.5 V	4.4	4.499		4.4		4.4		
			6 V	5.9	5.999		5.9		5.9		
		I _{OH} = -4 mA	4.5 V	3.98	4.3		3.7		3.84		
		I _{OH} = -5.2 mA	6 V	5.48	5.8		5.2		5.34		
V _{OL}	V _I = V _{IH} or V _{IL}	I _{OL} = 20 μA	2 V		0.002	0.1		0.1		0.1	V
			4.5 V		0.001	0.1		0.1		0.1	
			6 V		0.001	0.1		0.1		0.1	
		I _{OL} = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
		I _{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
I _I	V _I = V _{CC} or 0		6 V		±0.1	±100		±1000		±1000	nA
I _{CC}	V _I = V _{CC} or 0, I _O = 0		6 V			8		160		80	μA
C _i			2 V to 6 V		3	10		10		10	pF



SN54HC191, SN74HC191

4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V _{CC}	T _A = 25°C		SN54HC191		SN74HC191		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	2 V	4.2		2.8		3.3		MHz
		4.5 V	21		14		17		
		6 V	24		16		19		
t _w	$\overline{\text{LOAD}}$ low	2 V	120		180		150	ns	
		4.5 V	24		36		30		
		6 V	21		31		26		
	CLK high or low	2 V	120		180		150		
		4.5 V	24		36		30		
		6 V	21		31		26		
t _{su}	Data before $\overline{\text{LOAD}}\uparrow$	2 V	150		230		188	ns	
		4.5 V	30		46		38		
		6 V	25		38		32		
	$\overline{\text{CTEN}}$ before CLK \uparrow	2 V	205		306		255		
		4.5 V	41		61		51		
		6 V	35		53		44		
	D/ $\overline{\text{U}}$ before CLK \uparrow	2 V	205		306		255		
		4.5 V	41		61		51		
		6 V	35		53		44		
	$\overline{\text{LOAD}}$ inactive before CLK \uparrow	2 V	150		225		190		
		4.5 V	30		45		38		
		6 V	25		38		32		
t _h	Data after $\overline{\text{LOAD}}\uparrow$	2 V	5		5		5	ns	
		4.5 V	5		5		5		
		6 V	5		5		5		
	$\overline{\text{CTEN}}$ after CLK \uparrow	2 V	5		5		5		
		4.5 V	5		5		5		
		6 V	5		5		5		
	D/ $\overline{\text{U}}$ after CLK \uparrow	2 V	5		5		5		
		4.5 V	5		5		5		
		6 V	5		5		5		

SN54HC191, SN74HC191

4-BIT SYNCHRONOUS UP/DOWN BINARY COUNTERS

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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

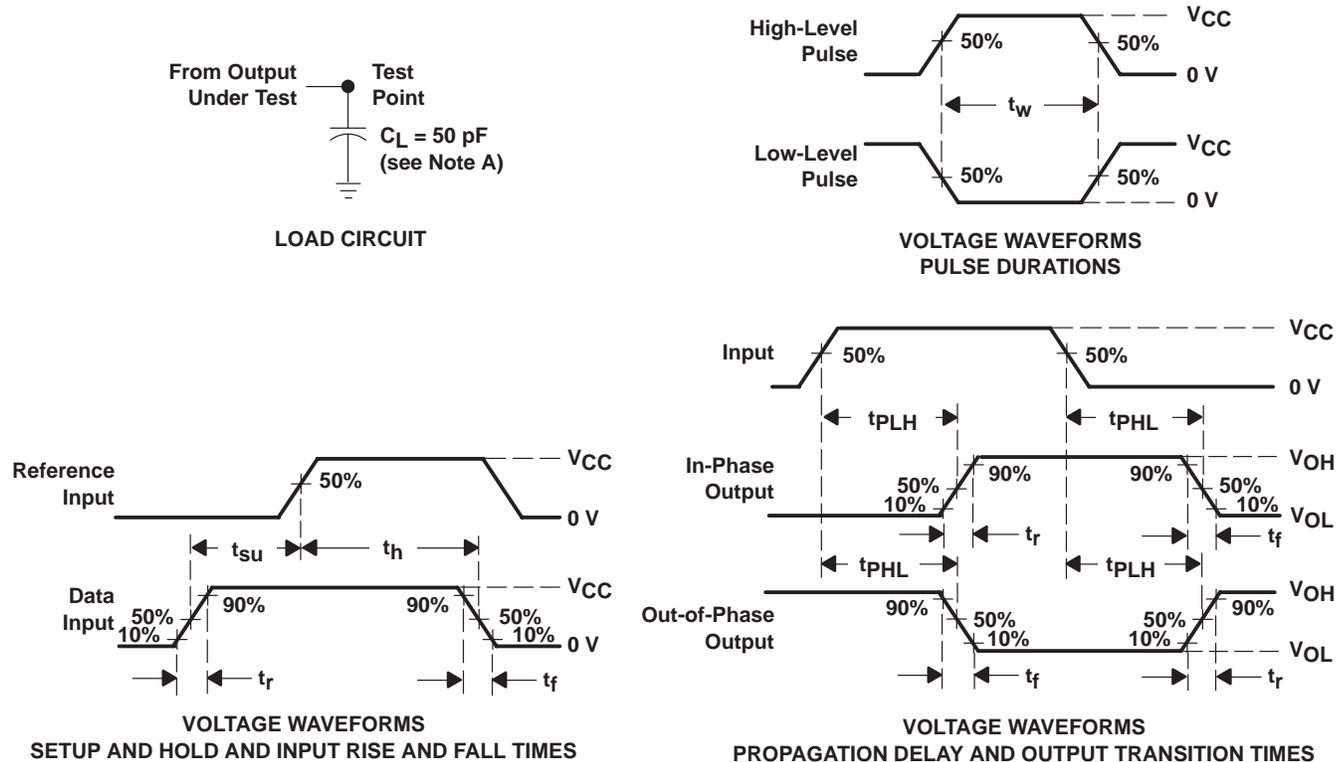
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	$T_A = 25^\circ\text{C}$			SN54HC191		SN74HC191		UNIT	
				MIN	TYP	MAX	MIN	MAX	MIN	MAX		
f_{\max}			2 V	4.2	8		2.8		3.3	MHz		
			4.5 V	21	42		14		17			
			6 V	24	48		16		19			
t_{pd}	$\overline{\text{LOAD}}$	Any Q	2 V		130	264		396		330	ns	
			4.5 V		40	53		79		66		
			6 V		33	45		67		56		
	A, B, C, or D	$Q_A, Q_B, Q_C,$ or Q_D	2 V		135	240		360		300		
			4.5 V		36	48		72		60		
			6 V		30	41		61		51		
	CLK	$\overline{\text{RCO}}$	2 V		58	120		180		150		
			4.5 V		17	24		36		30		
			6 V		14	21		31		26		
		Any Q	2 V		107	192		288		240		
			4.5 V		31	38		58		48		
			6 V		26	32		49		41		
		MAX/MIN	2 V		123	252		378		315		
			4.5 V		39	50		76		63		
			6 V		32	43		65		54		
		D/ \overline{U}	$\overline{\text{RCO}}$	2 V		102	228		342			285
				4.5 V		29	46		68			57
				6 V		24	38		59			49
	MAX/MIN		2 V		86	192		288		240		
			4.5 V		24	38		58		48		
			6 V		20	32		49		41		
	$\overline{\text{CTEN}}$	$\overline{\text{RCO}}$	2 V		50	132		198		165		
			4.5 V		15	26		40		33		
			6 V		13	23		34		28		
t_t		Any	2 V		38	75		110		95	ns	
			4.5 V		8	15		22		19		
			6 V		6	13		19		16		

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load	50	pF



PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 - C. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-86891012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86891012A SNJ54HC 191FK
5962-8689101EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8689101EA SNJ54HC191J
SN54HC191J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54HC191J
SN54HC191J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54HC191J
SN74HC191D	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-40 to 85	HC191
SN74HC191DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC191
SN74HC191DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC191
SN74HC191DT	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-40 to 85	HC191
SN74HC191N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN74HC191N
SN74HC191N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN74HC191N
SN74HC191NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC191
SN74HC191NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC191
SN74HC191NSR.B	Active	Production	SOP (NS) 16	2000 LARGE T&R	-	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC191
SNJ54HC191FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86891012A SNJ54HC 191FK
SNJ54HC191FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86891012A SNJ54HC 191FK
SNJ54HC191J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8689101EA SNJ54HC191J
SNJ54HC191J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8689101EA SNJ54HC191J

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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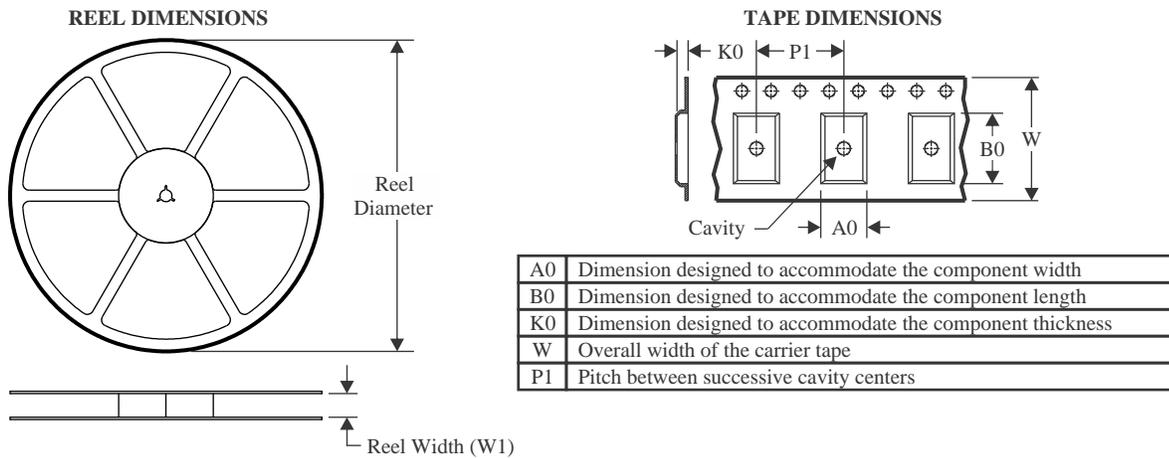
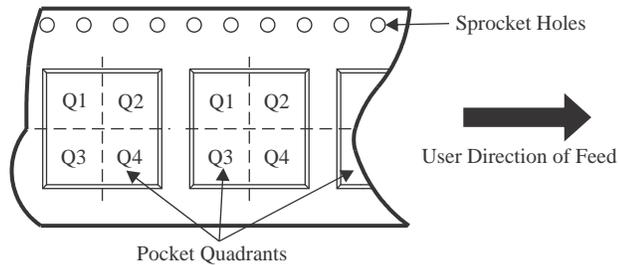
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54HC191, SN74HC191 :

- Catalog : [SN74HC191](#)
- Military : [SN54HC191](#)

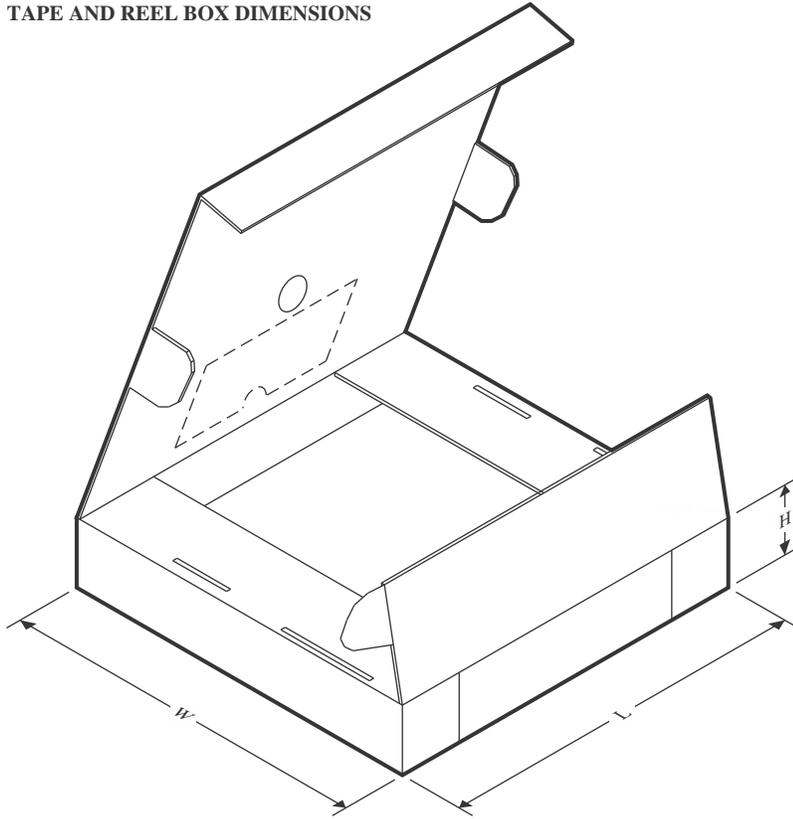
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


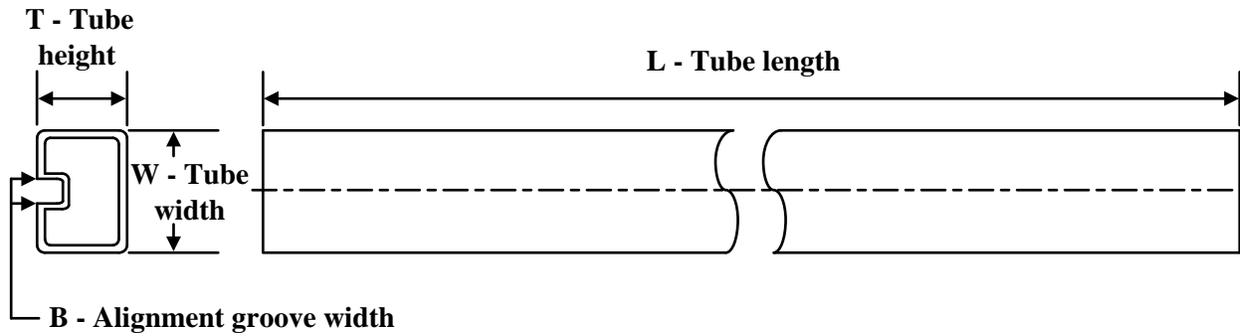
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC191DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74HC191NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74HC191DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74HC191NSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-86891012A	FK	LCCC	20	55	506.98	12.06	2030	NA
SN74HC191N	N	PDIP	16	25	506	13.97	11230	4.32
SN74HC191N	N	PDIP	16	25	506	13.97	11230	4.32
SN74HC191N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74HC191N.A	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54HC191FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54HC191FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA

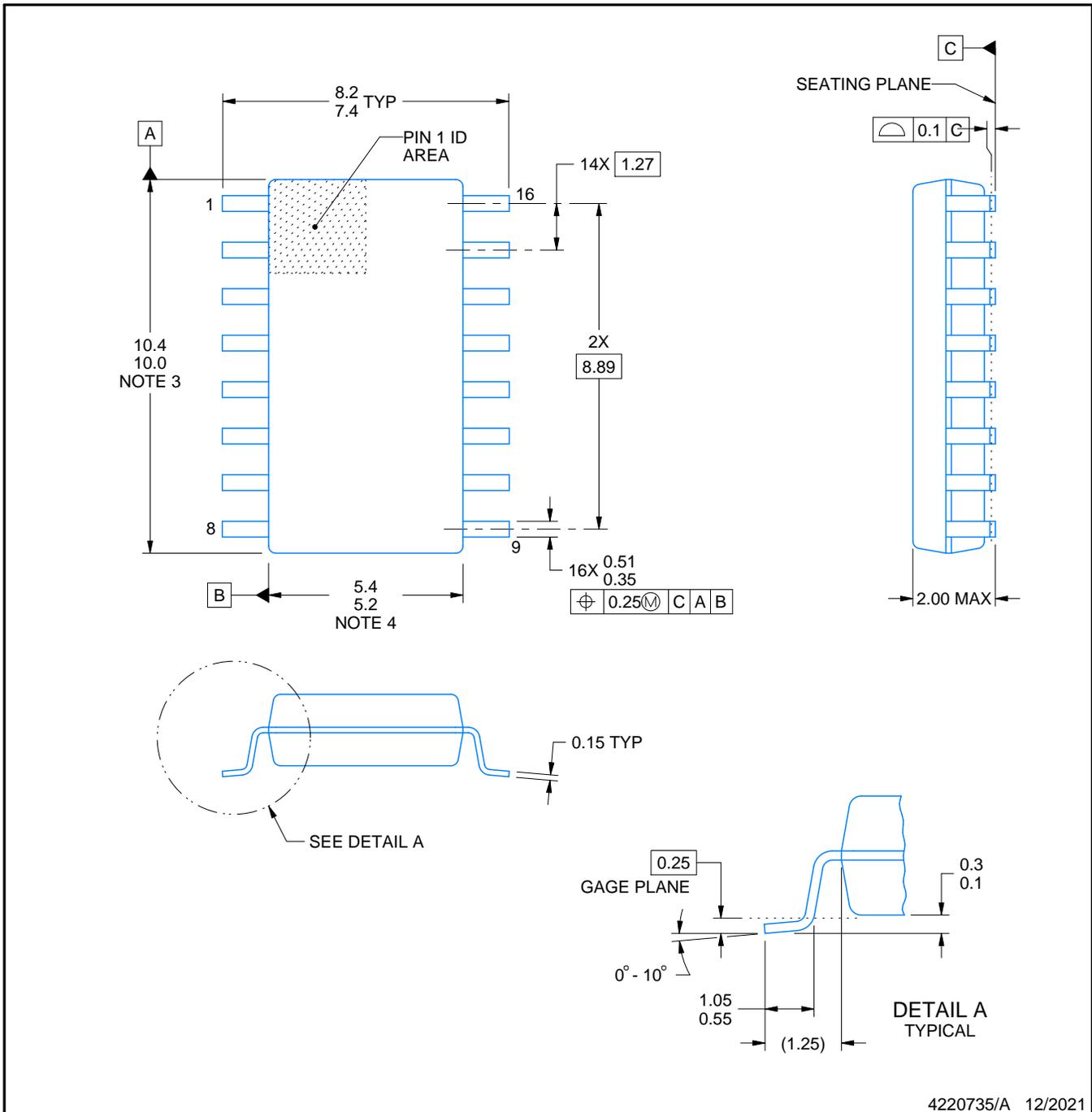


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES:

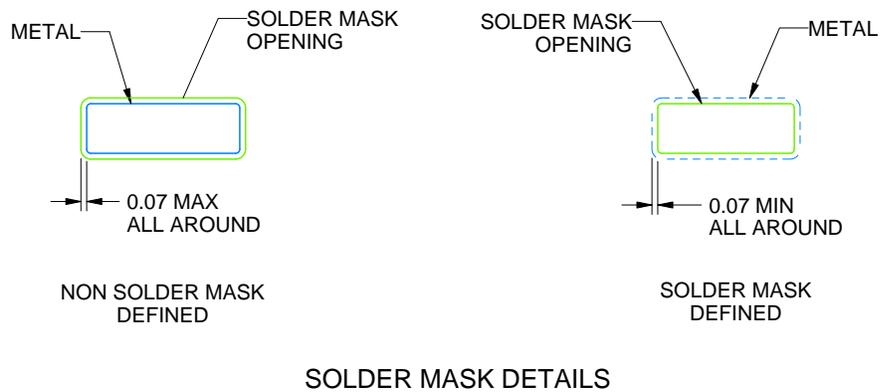
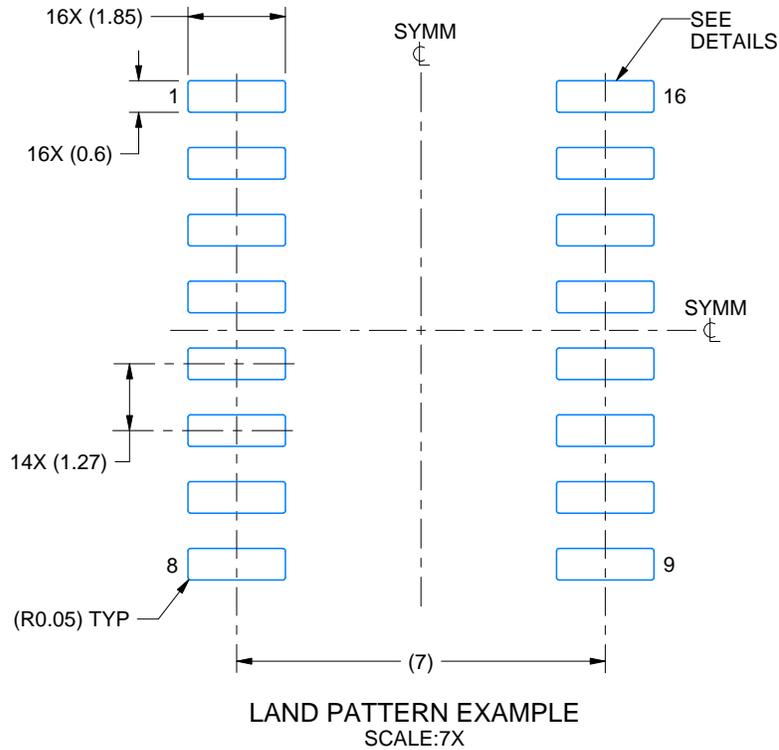
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

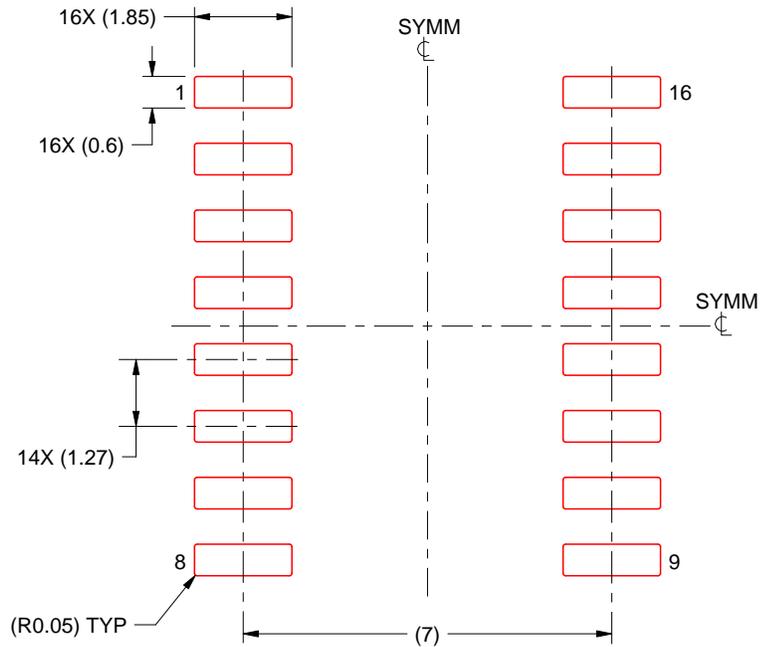
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

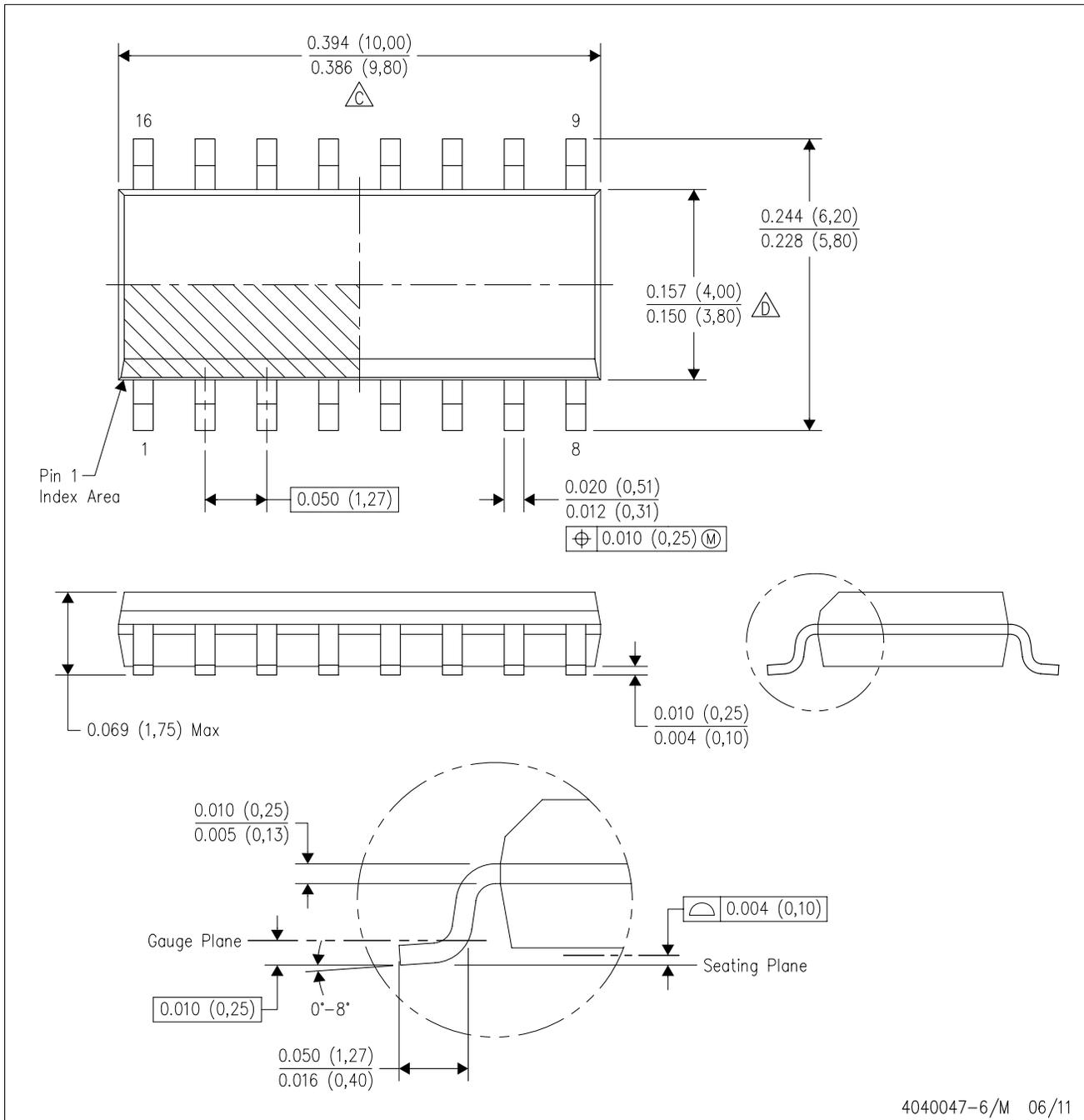
4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



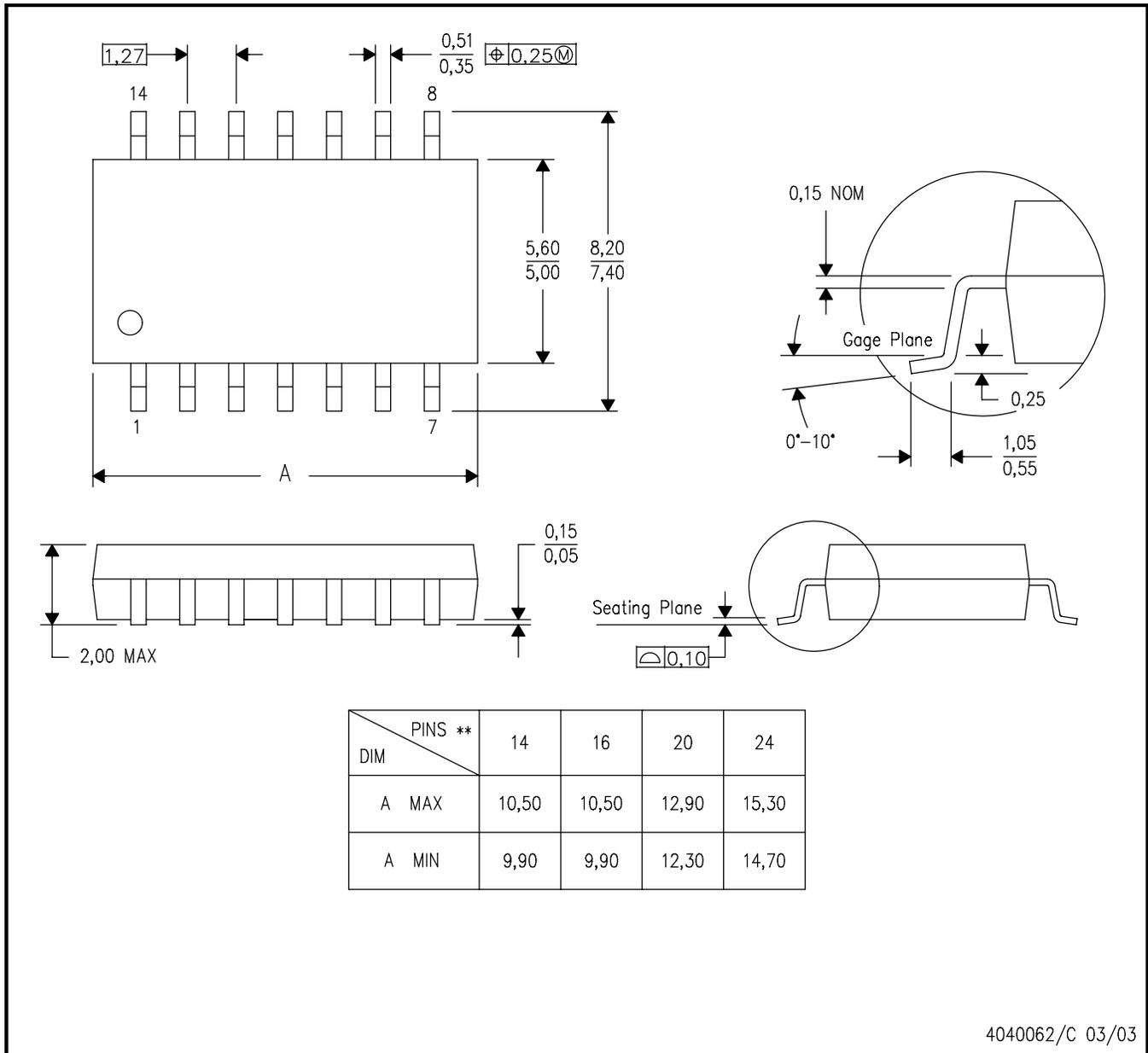
- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 -  D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

GENERIC PACKAGE VIEW

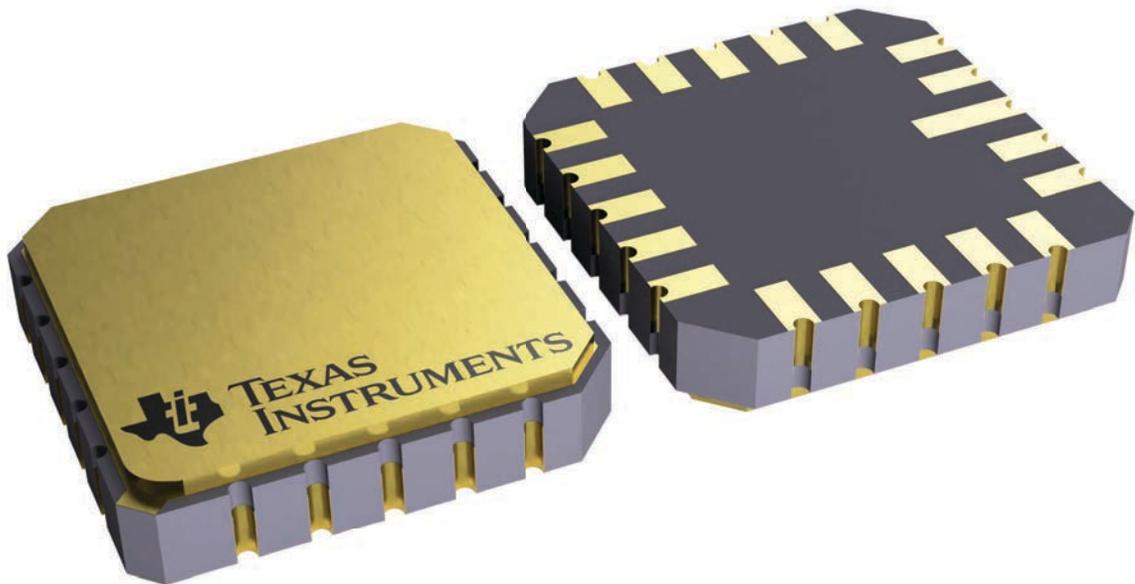
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

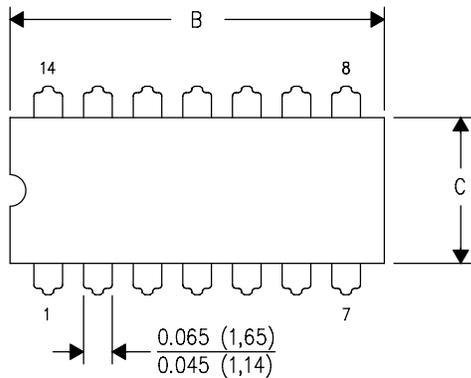


4229370VA\

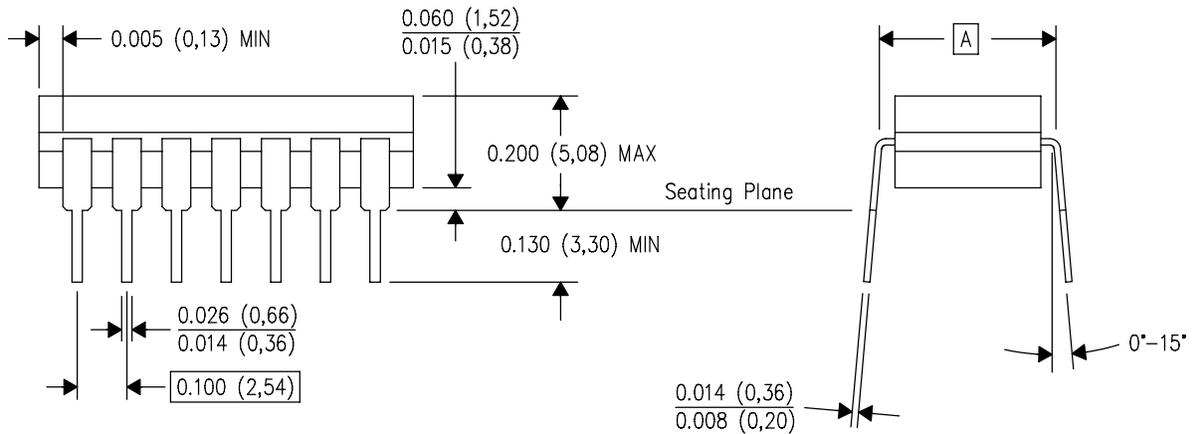
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



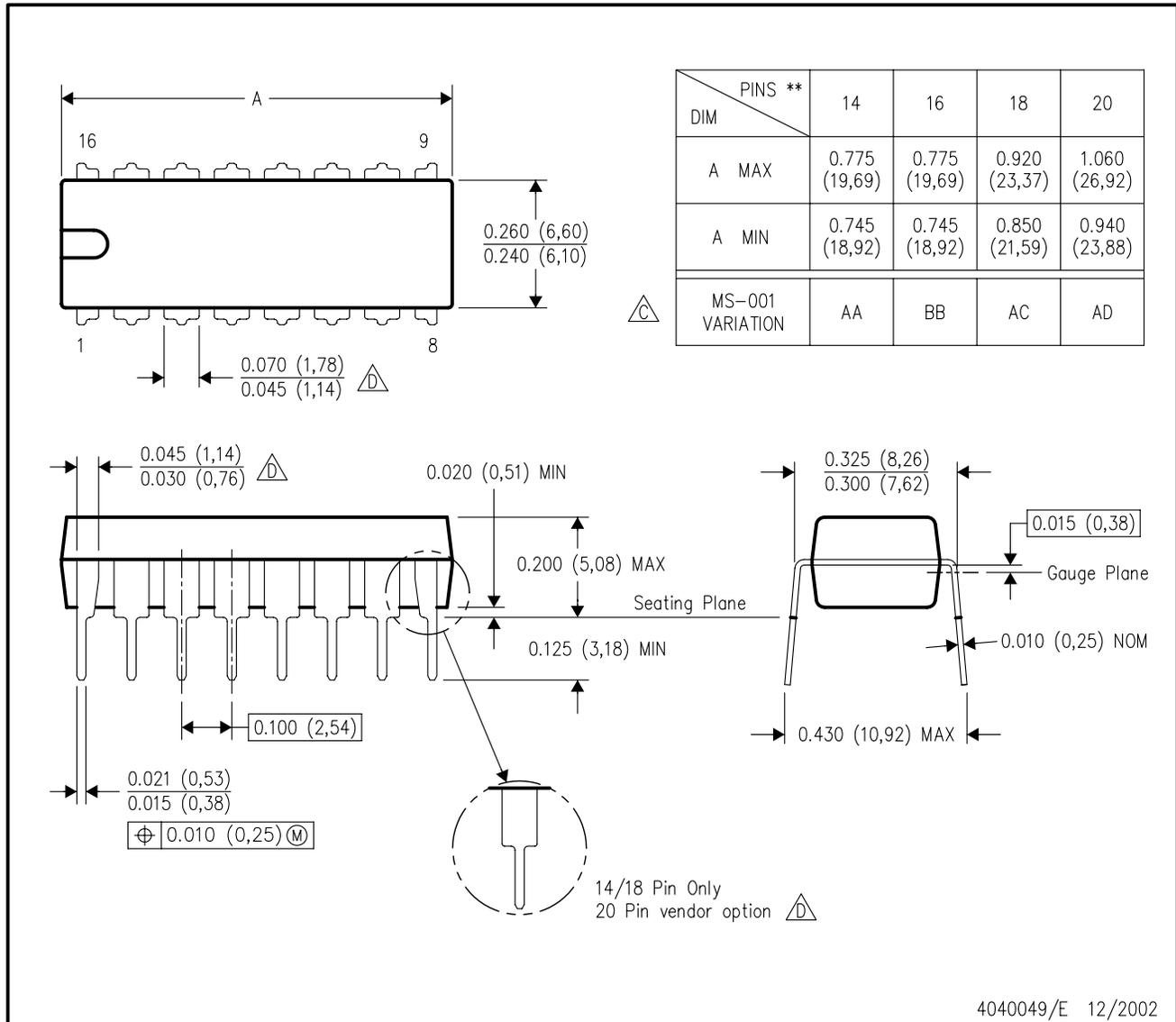
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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